# imall

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### Introduction

KEMET has developed a new type of tantalum capacitor that replaces the solid manganese dioxide electrode with a solid conductive polymer. This product is named the KO-CAP for KEMET Organic Capacitor. The basic families are the T520 and T530 series. A separate detail of performance characteristics is presented here as there are some differences between the polymer tantalums and the standard MnO2 types. Like all KEMET tantalum chips, these series are 100% screened for all electrical parameters: Capacitance @ 120 Hz, Dissipation Factor (DF) @ 120 Hz, ESR @ 100 kHZ and DC Leakage. It is also 100% surge current tested at full rated voltage through a low impedance circuit. The advantages of the polymer include very low ESR and elimination of the potentially catastrophic failure mode that may occur with standard tantalum capacitors in a high surge current application. Although the natural KO-CAP series failure mechanism is a short circuit, it does not exhibit an explosive failure mode.

### ELECTRICAL

1. Operating Temperature Range • -55°C to +105°C

Above  $85^{\circ}$ C, the voltage rating is reduced linearly from 1.0 x rated voltage to 0.8 x rated voltage at  $105^{\circ}$ C.

### 2. Non-Operating Temperature Range

• -55°C to +105°C

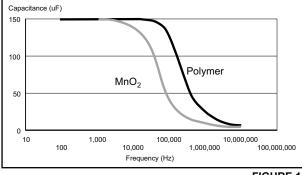
### 3. Capacitance and Tolerance

• 33µF to 1500µF

### • ±20% Tolerance

Capacitance is measured at 120 Hz, up to 1.0 volt rms maximum and up to 2.5V DC maximum. DC bias causes only a small reduction in capacitance, up to about 2% when full rated voltage is applied. DC bias is not commonly used for room temperature measurements but is more commonly used when measuring at temperature extremes.

Capacitance does decrease with increasing frequency, but not nearly as much or as quickly as standard tantalums. Figure 1 compares the frequency induced cap rolloff between the KO-CAP and traditional MnO2 types. Capacitance also increases with increasing temperature. See section 12 for temperature coefficients.



#### FIGURE 1

### 4. Voltage Ratings

### 2V-16V DC Rated Voltage

This is the maximum peak DC operating voltage from  $-55^{\circ}$ C to  $+85^{\circ}$ C for continuous duty. Above  $85^{\circ}$ C, this voltage is derated linearly to 0.8 times the rated voltage for operation at  $105^{\circ}$ C.

### Surge Voltage Ratings

Surge voltage is the maximum voltage to which the part can be subjected under transient conditions including the sum of peak AC ripple, DC bias and any transients. Surge voltage capability is demonstrated by application of 1000 cycles of the relevant voltage, at 25°C, 85°C or 105°C. The parts are charged through a 33 ohm resistor for 30 seconds and then discharged through a 33 ohm resistor for 30 seconds for each cycle.

### Voltage Ratings Table 1

Rated	Surge	Derated	Derated
Voltage	Voltage	Voltage	Surge
			Voltage
-55ºC	to +85ºC	+1(	)5ºC
2V	2.6V	1.6V	2.1V
2.5V	3.3V	2.0V	2.8V
3V	3.9V	2.4V	3.1V
4V	5.2V	3.3V	4.3V
6.3V	8V	5V	6.5V
8V	10.4V	6.4V	8.7V
10V	13V	8V	10.4V
16V	20.8V	12.8V	16.6V

### 5. Reverse Voltage Rating & Polarity

Polymer tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected in the wrong polarity. The positive terminal is identified by a laser-marked stripe and may also include a beveled edge. These capacitors will withstand a small degree of transient voltage reversal for short periods as shown in the following table. Please note that these parts may not be operated continuously in reverse, even within these limits.

Table 2						
Temperature Permissible Transient Reverse Voltage						
25ºC	15% of Rated Voltage					
55ºC	10% of Rated Voltage					
85ºC	5% of Rated Voltage					
105ºC	3% of Rated Voltage					

### 6. DC Leakage Current

Because of the high conductivity of the polymer, the KO-CAP family has higher leakage currents than traditional MnO2 type Tantalum caps. The DC Leakage limits at 25°C are calculated as 0.1 x C x V, where C is cap in  $\mu$ F and V is rated voltage in Volts. Limits for all part numbers are listed in the ratings tables.

DC Leakage current is the current that flows through the capacitor dielectric after a five minute charging period at rated voltage. Leakage is measured at 25°C with full rated voltage applied to the capacitor through a 1000 ohm resistor in series with the capacitor.



DC Leakage current does increase with temperature. The limits for  $85^{\circ}$ C @ Rated Voltage and  $105^{\circ}$ C @ 0.8 x Rated Voltage are both 10 times the  $25^{\circ}$ C limit.

### 7. Surge Current Capability

Certain applications may induce heavy surge currents when circuit impedance is very low (<0.1 ohm per volt). Driving inductance may also cause voltage ringing. Surge currents may appear as transients during turn-on of equipment.

The KO-CAP has a very high tolerance for surge current. And although the failure mechanism is a short circuit, they do not explode as may occur with standard tantalums in such applications.

The KO-CAP series receives 100% screening for surge current in our production process. Capacitors are surged 4 times at full rated voltage applied through a total circuit resistance of <0.5 ohms. Failures are removed during subsequent electrical testing.

### 8. Dissipation Factor (DF)

Refer to part number tables for maximum DF limits.

Dissipation factor is measured at 120 Hz, up to 1.0 volt rms maximum, and up to 2.5 volts DC maximum at +25°C. The application of DC bias causes a small reduction in DF, about 0.2% when full rated voltage is applied. DF increases with increasing frequency.

Dissipation factor is the ratio of the equivalent series resistance (ESR) to the capacitive reactance, ( $X_c$ ) and is usually expressed as a percentage. It is directly proportional to both capacitance and frequency. Dissipation factor loses its importance at higher frequencies, (above about 1 kHz), where impedance (Z) and equivalent series resistance (ESR) are the normal parameters of concern. DF = R = 2  $\pi$ f CR DF= Dissipation Factor

	01-0	nooipation i aotoi
X <sub>c</sub>	R=	Equivalent Series
		Resistance (Ohms)
	$X_{c} =$	Capacitive Reactance

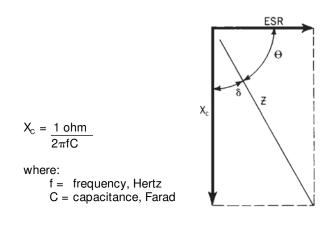
- (Ohms)
- f= Frequency (Hertz)
- C= Series Capacitance (Farads)

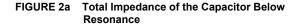
DF is also referred to as tan  $\delta$  or "loss tangent." The "Quality Factor," "Q," is the reciprocal of DF.

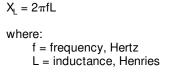
## 9. Equivalent Series Resistance (ESR) and Impedance (Z)

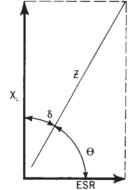
The Equivalent Series Resistance (ESR) of the KO-CAP is much lower than standard Tantalum caps because the polymer cathode has much higher conductivity. ESR is not a pure resistance, and it decreases with increasing frequency.

Total impedance of the capacitor is the vector sum of capacitive reactance ( $X_c$ ) and ESR, below resonance; above resonance total impedance is the vector sum of inductive reactance ( $X_L$ ) and ESR.









## FIGURE 2b Total Impedance of the Capacitor Above Resonance

To understand the many elements of a capacitor, see Figure 3.

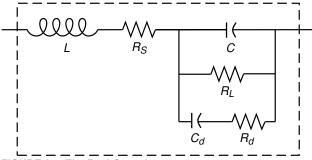


FIGURE 3 The Real Capacitor

A capacitor is a complex impedance consisting of many series and parallel elements, each adding to the complexity of the measurement system.

L — Represents lead wire and construction inductance. In most instances (especially in solid tantalum and monolithic ceramic capacitors) it is insignificant at the basic measurement frequencies of 120 and 1000 Hz.

 $\rm R_{s}$  — Represents the actual ohmic series resistance in series with the capacitance. Lead wires and capacitor electrodes are contributing sources.

 $R_{L}$  — Capacitor Leakage Resistance. Typically it can reach 50,000 megohms in a tantalum capacitor. It can exceed 10<sup>12</sup> ohms in monolithic ceramics and in film capacitors.

 $R_d$  — The dielectric loss contributed by dielectric absorption and molecular polarization. It becomes very significant in high frequency measurements and applications. Its value varies with frequency.

 $C_{d}$  — The inherent dielectric absorption of the solid tantalum capacitor which typically equates to 1-2% of the applied voltage.

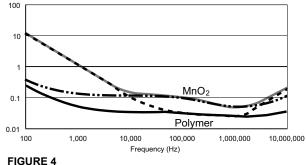
As frequency increases,  $X_c$  continues to decrease according to its equation above. There is unavoidable inductance as well as resistance in all capacitors, and at some point in frequency, the reactance ceases to be capacitive and becomes inductive. This frequency is called the self-resonant point. In solid tantalum capacitors, the resonance is damped by the ESR, and a smooth, rather than abrupt, transition from capacitive to inductive reactance follows.

Figure 4 compares the frequency response of a KO-CAP to a standard Tantalum chip. See also frequency curves shown in the T520 section, p.39. Maximum limits for 100 kHz ESR are listed in the part number tables for each series.

The T530 Capacitance, Impedance and ESR vs. Frequency Comparisions are located on page 43. Maximum limits for 100 kHz are listed in the part number table on page 42.



T495D 150 uF (MnO<sub>2</sub>) vs. T520D 150 uF (Polymer)



### 10. AC Power Dissipation

Power dissipation is a function of capacitor size and materials. Maximum power ratings have been established for all case sizes to prevent overheating. In actual use, the capacitor's ability to dissipate the heat generated at any given power level may be affected by a variety of circuit factors. These include board density, pad size, heat sinks and air circulation.

	Table 3	
Tantalum Chip	Power Dissipation Ratings	

Case	e Code	Maximum Power Dissipation
KEMET	EIA	mWatts @+25°C w/+20°C Rise
T520/T	3528-12	70
T520/B	3528-21	85
T520/V 7343-20		125
T520/D	7343-31	150
T520/Y	7343-40	156
T520/X	7343-43	165
T530/D	7343-31	255
T530/X	7343-43	270
T530/E	7260-38	285

### 11. AC Operation

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and power dissipation capability.

Permissible AC ripple voltage which may be applied is limited by three criteria:

- a. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.
- b. The negative peak AC voltage, in combination with bias voltage, if any, must not exceed the permissible reverse voltage ratings presented in Section 5.
- c. The power dissipated in the ESR of the capacitor must not exceed the appropriate value specified in Section 10.

KEMET Electronics Corporation, P.O. Box 5928, Greenville, S.C. 29606, (864) 963-6300



Actual power dissipated may be calculated from the following:

 $P = I^2 R$ 

Substituting I =  $\underline{E}$ , P =  $\underline{E}^2 R$ Z Z<sup>2</sup>

where:

- I = rms ripple current (amperes)
- E = rms ripple voltage (volts)
- P = power (watts)
- Z = impedance at specified frequency (ohms)
- R = equivalent series resistance at specified frequency (ohms)

Using P max from Table 3, maximum allowable rms ripple current or voltage may be determined as follows:

 $I(max) = \sqrt{P max/R}$  E(max) = Z  $\sqrt{P max/R}$ These values should be derated at elevated temperatures as follows:

Temperature	Derating Factor
85ºC	.9
105ºC	.4

### **ENVIRONMENTAL**

### **12. Temperature Stability**

Mounted capacitors withstand extreme temperature testing at a succession of continuous steps at  $+25^{\circ}$ C,  $-55^{\circ}$ C,  $+25^{\circ}$ C,  $+85^{\circ}$ C,  $+105^{\circ}$ C,  $+25^{\circ}$ C in that order. Capacitors are allowed to stabilize at each temperature before measurement. Cap, DF, and DCL are measured at each temperature except DC Leakage is not measured at  $-55^{\circ}$ C.

### Table 4

Acceptable limits are as follows:

	- <u>-</u>			
Step	Temp.	∆Cap	DCL	DF
1	+25ºC	Specified	Catalog	Catalog
		Tolerance	Limit	Limit
2	-55ºC	±20% of	N/A	Catalog
		initial value		Limit
3	+25ºC	±10% of	Catalog	Catalog
		initial value	Limit	Limit
4	+85ºC	±20% of	10x Catalog	1.2x Catalog
		initial value	Limit	Limit
5	+105ºC	±30% of	10x Catalog	1.5x Catalog
		initial value	Limit	Limit
6	+25ºC	±10% of	Catalog	Catalog
		initial value	Limit	Limit

### 13. Standard Life Test

### • 85°C, Rated Voltage, 2000 Hours

- Post Test Performance:
- a. Capacitance: within -20%/+10% of initial value
- b. DF: within initial limit
- c. DC Leakage: within initial limit
- d. ESR: within initial limit

- 14. High Temperature Life Test
  - 105℃, 0.8 x Rated Voltage, 2000 hours

### Post Test Performance:

- a. Capacitance: within -20%/+10% of initial value
- b. DF: within initial limit
- c. DC Leakage: within 1.25 x initial limit
- d. ESR: within 2 x initial limit

### 15. Storage Life Test

### • 105°C, 0VDC, 2000 Hours

- Post Test Perfomance:
  - a. Capacitance: within -20%/+10% of initial value
- b. DF: within initial limit
- c. DC Leakage: within 1.25 x initial limit
- d. ESR: within 2 x initial limit

### 16. Thermal Shock

### Mil-Std-202, Method 107, Condition B

Minimum temperature is -55°C Maximum temperature is +105°C 500 Cycles

Post Test Performance:

- a. Capacitance: within +10%/-20% of initial value
- b. DF: within initial limit
- c. DC Leakage: within initial limit
- d. ESR: within 2 x initial limit

### 17. Moisture Resistance Testing

### • J-Std-020

Steps 7a and 7b excluded, 0V, 21 cycles Post Test Performance:

- a. Capacitance: within ±30% of initial value
- b. DF: within initial limit
- c. DC Leakage: within initial limit
- d. ESR: within initial limit

### 18. Load Humidity

• 85°C, 85% RH, Rated Voltage, 500 Hours

- Post Test Performance:
- a. Capacitance: within +35%/-5% of initial value
- b. DF: within initial limit
- c. DC Leakage: within 5 x initial limit
- d. ESR: within 2 x initial limit

### 19. ESD

• Polymer tantalum capacitors are not sensitive to Electro-Static Discharge (ESD).

### 20. Failure Mechanism and Reliability

The normal failure mechanism is dielectric breakdown. Dielectric failure can result in high DC Leakage current and may proceed to the level of a short circuit. With sufficient time to charge, healing may occur by one of two potential mechanisms. The polymer adjacent to the dielectric fault site may overheat and vaporize, disconnecting the fault site from the circuit. The polymer may also

oxidize into a more resistive material that plugs the defect site in the dielectric and reduces the flow of current.

Capacitor failure may be induced by exceeding the rated conditions of forward DC voltage, reverse DC voltage, surge current, power dissipation or temperature. Excessive environmental stress, such as prolonged or high temperature reflow processes may also trigger dielectric failure.

Failure rates may be improved in application by derating the voltage applied to the capacitor. KEMET recommends that KO-CAPs be derated to 80% or less of the rated voltage in application.

KO-CAPs exhibit a benign failure mode in that they do not fail catastophically even under typical fault conditions. If a shorted capacitor is allowed to pass unlimited current, it may overheat and the case may discolor. But this is distinctly different from the explosive "ignition" that may occur with standard MnO2 cathode tantalums. Replacement of the MnO2 by the polymer removes the oxygen that fuels ignition during a failure event.

### MECHANICAL

### 21. Resistance to Solvents

### • Mil-Std-202, Method 215

Post Test Performance:

- a. Capacitance within ±10% of initial value
- b. DC Leakage within initial limit
- c. Dissipation Factor within initial limit
- d. ESR within initial limit
- e. Physical no degradation of case, terminals or marking

### 22. Fungus

Mil-Std-810, Method 508

### 23. Flammability

UL94 VO Classification

Encapsulant materials meet this classifaction

### 24. Resistance to Soldering Heat

 Maximum Reflow +240 ±5°C, 10 seconds

### Typical Reflow

### +230 ±5°C, 30 seconds

Post Test Performance:

- a. Capacitance within  $\pm 10\%$  of initial value b. DC Leakage within initial limit
- c. Dissipation Factor within initial limit
- d. ESR within initial limit

### 25. Solderability

- Mil-Std-202, Method 208
- ANSI/J-STD-002, Test B

Applies to Solder Coated terminations only.

### 26. Vibration

 Mil-Std-202, Method 204, Condition D, 10 Hz to 2.000 Hz. 20G Peak

### Post Test Performance:

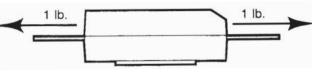
- a. Capacitance within  $\pm 10\%$  of initial value b. DC Leakage within initial limit
- c. Dissipation Factor within initial limit
- d. ESR within initial limit

### 27. Shock

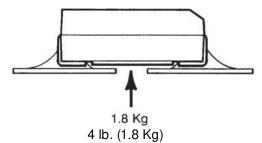
### • Mil-Std-202, Method 213, Condition I, 100 G Peak

Post Test Performance:

- a. Capacitance within ±10% of initial value
- b. DC Leakage within initial limit
- c. Dissipation Factor within initial limit
- d. ESR within initial limit
- 28. Terminal Strength
  - Pull Force
    - One Pound (454 grams), 30 Seconds



- Tensile Force
  - Four Pounds (1.8 kilograms), 60 Seconds

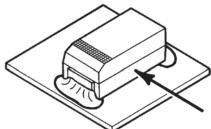


### Shear Force Table 5 Maximum Shear Loads

Cas	Case Code		near Loads
KEMET	EIA	Kilograms	Pounds
В	3528-21	3.6	8.0
V	7343-20	5.0	11.0
D	7343-31	5.0	11.0
Х	7343-43	5.0	11.0

Post Test Performance:

- a. Capacitance within  $\pm 5\%$  of initial value b. DC Leakage within initial limit
- c. Dissipation Factor within initial limit
- d. ESR within initial limit



# COMPONENT PERFORMANCE CHARACTERISTICS APPLICATIONS bigh integrity colder fillete Brok

#### 29. Handling

Automatic handling of encapsulated components is enhanced by the molded case which provides compatibility with all types of high speed pick and place equipment. Manual handling of these devices presents no unique problems. Care should be taken with your fingers, however, to avoid touching the solder-coated terminations as body oils, acids and salts will degrade the solderability of these terminations. Finger cots should be used whenever manually handling all solderable surfaces.

#### **30. Termination Coating**

The standard finish coating is 90/10 Sn/Pb solder (Tin/Lead-solder coated). 100% tin coating is available upon request.

#### 31. Recommended Mounting Pad Geometries

Proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to maximize the intergrity of the solder joint, and to minimize component rework due to unacceptable solder joints.

Figure 5 illustrates pad geometry. The table provides recommended pad dimensions for reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers, to be fine tuned, if necessary, based upon the peculiarities of the soldering process and/or circuit board design.

Contact KEMET for Engineering Bulletin Number F-2100 entitled "Surface Mount Mounting Pad Dimensions and Considerations" for further details on this subject.

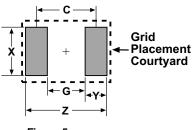


Figure 5

#### Table 6 - Land Pattern Dimensions for Reflow Solder

		Pa	d Dim	ensior	าร
KEMET/EIA Size Code				Y	C
	Ζ	G	Х	(ref)	(ref)
B/3528-21	5.00	1.10	2.50	1.95	3.05
D/7343-31, V/7343-20, X/7343-43	8.90	3.80	2.70	2.55	6.35

#### 32. Soldering

The T520 KO-CAP family has been designed for reflow solder processes. They are not recommended for wave solder. Solder-coated terminations have excellent wetting characteristics for high integrity solder fillets. Preheating of these components is recommended to avoid extreme thermal stress. The maximum recommended preheat rate is 2°C per second.

Hand-soldering should be avoided. If necessary, it should be performed with care due to the difficulty in process control. Care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. The iron should be removed. "Wiping" the edges of a chip and heating the top surface is not recommended.

During typical reflow operations a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and is not harmful to the product. Marking permanency is not affected by this change.

#### 33. Washing

Standard washing techniques and solvents are compatible with all KEMET surface mount tantalum capacitors. Solvents such as Freon TMC and TMS, Trichlorethane, methylene chloride, prelete, and isopropyl alcohol are not harmful to these components. Please note that we are not endorsing the use of banned or restricted solvents. We are simply stating that they would not be harmful to the components.

If ultrasonic agitation is utilized in the cleaning process, care should be taken to minimize energy levels and exposure times to avoid damage to the terminations.

KEMET tantalum chips are also compatible with newer aqueous and semi-aqueous processes.

#### 34. Encapsulations

Under normal circumstances, potting or encapsulation of KEMET tantalum chips is not required.

#### 35. Storage Environment

Tantalum chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature - reels may soften or warp, and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40 degrees C, and the maximum storage humidity not exceed 60% relative humidity. In addition, temperature fluctuations should be minimized to avoid condensation on the parts, and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within 1.5 years of receipt.

### POLYMER TANTALUM CHIP CAPACITORS KEMET **T520 SERIES**

Voltage 2V to 25V

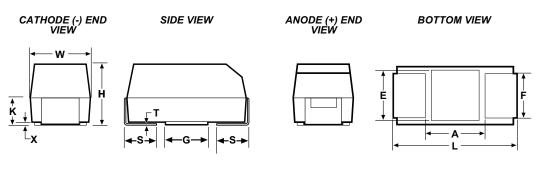
EIA Standard Case Sizes

100% Surge Current Tested

### **FEATURES** Capacitance 15 to 1000µF (±20%)

- Polymer Cathode Technology
- Low ESR
- High Frequency Cap Retention
- No-Ignition Failure Mode
- Use Up to 80% of Rated Voltage (20% Derating)

### **OUTLINE DRAWING**



### **DIMENSIONS - MILLIMETERS**

Ca	ise Size											
KEMET	EIA	L	W	Н	K ±0.20	F ±0.1	S ±0.3	X(Ref)	T(Ref)	A(Min)	G(ref)	E(ref)
Т	3528-12	$3.5 \pm 0.2$	2.8 ± 0.2	1.2 max	0.3	2.2	0.8	0.05	0.13	1.1	1.8	2.2
В	3528-21	$3.5 \pm 0.2$	2.8 ± 0.2	1.9 ± 0.2	0.9	2.2	0.8	0.10 ± 0.10	0.13	1.1	1.8	2.2
V	7343-20	$7.3 \pm 0.3$	4.3 ± 0.3	1.9 max	0.9	2.4	1.3	0.05	0.13	3.8	3.5	3.5
D	7343-31	$7.3 \pm 0.3$	4.3 ± 0.3	2.8 ± 0.3	1.5	2.4	1.3	0.10 ± 0.10	0.13	3.8	3.5	3.5
Y	7343-40	$7.3 \pm 0.3$	4.3 ± 0.3	4.0 max	1.9	2.4	1.3	0.10 ± 0.10	0.13	3.8	3.5	3.5
Х	7343-43	$7.3 \pm 0.3$	$4.3 \pm 0.3$	$4.0 \pm 0.3$	2.3	2.4	1.3	0.10 ± 0.10	0.13	3.8	3.5	3.5

### **T520 ORDERING INFORMATION**

520 V 157 M 006 A S E015

**Tantalum** 

Series T520 - Low ESR Polymer

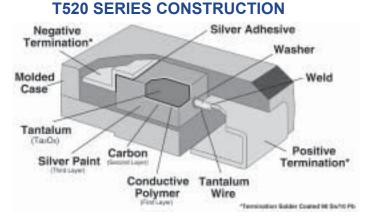
Case Size

B, V, D, X

Capacitance Picofarad Code

First two digits represent significant figures. Third digit specifies number of zeros to follow.

### **Capacitance Tolerance M** = ± 20%



- ESR

Lead Material

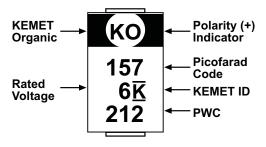
**Failure Rate** 

Voltage

A - Not Applicable

S - Standard Solder Coated

### **COMPONENT MARKING**



212 = 12th week of 2002

1	T520 RATINGS & PART NUMBER REFERENCE								
Capaci-	Case	KEMET Part Number	DC Leakage µA	DF% @ 25°C 120 Hz	ESR mΩ @ 25°C 100 kHz		pple Cur ( rms @ 2		
tance µF	Size		@ 25°C Max	Max	Max	1	00 kHz N	lax	
		2 Volt Rating	g @ +85°C (1.6 Vo	It Rating at 10	15°C)	25°C	85°C	105°C	
470.0	V	T520V477M002ASE040	94 ng @ 85°C (2.0 Vo	10 It Pating at 10	40	1.8	1.6	0.7	
100.0	В	T520B107M2R5ASE040	25	8	40	1.5	1.3	0.6	
100.0 220.0	B V	T520B107M2R5ASE070 T520V227M2R5ASE015	25 55	8 10	70 15	1.1 2.9	1.0 2.6	0.4	
220.0 220.0	V V	T520V227M2R5ASE025 T520V227M2R5ASE045	55 55	10 10	25 45	2.2	2.0 1.5	0.9 0.7	
330.0	V	T520V337M2R5ASE045	99	10	45 9	1.7 3.7	3.4	1.5	
330.0 330.0	V V	T520V337M2R5ASE015 T520V337M2R5ASE025	83 83	10 10	15 25	2.9 2.2	2.6 2.0	1.2 0.9	
470.0	V	T520V477M2R5ASE012	118	10	12	3.2	2.9	1.3	
470.0 680.0	V D	T520V477M2R5ASE015 T520D687M2R5ASE015	118 170	10 10	15 15	2.9 3.2	2.6 2.8	1.2 1.3	
680.0 680.0	D Y	T520D687M2R5ASE040 T520Y687M2R5ATE025	170 170	10 10	40 25	1.9 2.5	1.7 2.3	0.8 1.0	
1000.0	Ý	T520Y108M2R5ATE025	250	10	25	2.5	2.3	1.0	
100.0	В	3 Volt Ratin T520B107M003ASE040	g at 85°C (2.4 Vol 30	t Rating at 10	5°C) 40	1.5	1.3	0.6	
100.0	В	T520B107M003ASE070	30	8	70	1.1	1.0	0.4	
150.0 150.0	B B	T520B157M003ASE040 T520B157M003ASE070	45 45	8	40 70	1.5 1.1	1.3 1.0	0.6 0.4	
330.0 330.0	V V	T520V337M003ASE012 T520V337M003ASE015	99 99	10 10	12 15	3.2 2.9	2.9 2.6	1.3 1.2	
330.0	V	T520V337M003ASE025	99	10	25	2.2	2.0	0.9	
680.0 680.0	D D	T520D687M003ASE015 T520D687M003ASE040	204 204	10 10	15 40	3.2 1.9	2.8 1.7	1.3 0.8	
1000.0 1000.0	X X	T520X108M003ASE015 T520X108M003ASE030	300 300	10 10	15 30	3.3 2.3	3.0 2.1	1.3 0.9	
		4 Volt Rating	@ +85°C (3.3 Vol	t Rating at +1	05°C)				
15.0 68.0	T B	T520T156M004ASE100 T520B686M004ASE040	6 27	8	100 40	0.8	0.7	0.3	
68.0	В	T520B686M004ASE070	27	8	70	1.1	1.0	0.4	
100.0 100.0	B B	T520B107M004ASE040 T520B107M004ASE070	40 40	8 8	40 70	1.5 1.1	1.3 1.0	0.6 0.4	
150.0 150.0	B B	T520B157M004ASE040 T520B157M004ASE070	60 60	8 8	40 70	1.5 1.1	1.3 1.0	0.6 0.4	
150.0	V	T520V157M004ASE015	60	10	15	2.9	2.6	1.2	
150.0 220.0	V V	T520V157M004ASE025 T520V227M004ASE015	60 88	10	25 15	2.2 2.9	2.0	0.9	
220.0	v	T520V227M004ASE025	88	10	25	2.2	2.0	0.9	
220.0 220.0	V D	T520V227M004ASE045 T520D227M004ASE065	88 88	10 10	45 65	1.7 1.5	1.5 1.4	0.7 0.6	
330.0 330.0	V V	T520V337M004ASE025 T520V337M004ASE040	132 132	10 10	25 40	2.2 1.8	2.0 1.6	0.9 0.7	
330.0	D	T520D337M004ASE015	132	10	15	3.2	2.8	1.3	
330.0 330.0	D D	T520D337M004ASE040 T520D337M004ASE045	132 132	10 10	40 45	1.9 1.8	1.7 1.6	0.8 0.7	
470.0	D	T520D477M004ASE012 T520D477M004ASE015	188	10	12	3.5	3.2	1.4	
470.0 470.0	D D	T520D477M004ASE015	188 188	10 10	15 18	3.2 2.9	2.8 2.6	1.3 1.2	
470.0 470.0	D D	T520D477M004ASE025 T520D477M004ASE040	188 188	10 10	25 40	2.4 1.9	2.2 1.7	1.0 0.8	
680.0	Y	T520Y687M004ATE025	272	10	25	2.5	2.3	1.0	
680.0 680.0	X X	T520X687M004ASE015 T520X687M004ASE035	272 272	10 10	15 35	3.3 2.2	3.0 2.0	1.3 0.9	
15.0	т	6/6.3 Volt Rati T520T156M006ASE100	ng @ +85°C (5 Vo 9.5	It Rating at +	105°C) 100	0.8	0.7	0.3	
33.0	В	T520B336M006ASE040	21	8	40	1.5	1.3	0.6	
33.0 <mark>33.0</mark>	B T	T520B336M006ASE070 T520T336M006ATE070	21 21	8 <mark>8</mark>	70 70	1.1 1	1.0 0.9	0.4 0.4	
47.0 47.0	B B	T520B476M006ASE040 T520B476M006ASE070	30 30	8	40 70	1.5 1.1	1.3 1.0	0.6 0.4	
68.0	В	T520B686M006ASE040	43	8	40	1.5	1.3	0.6	
68.0 100.0	B B	T520B686M006ASE070 T520B107M006ASE040	43 63	8	70 40	1.1 1.5	1.0 1.3	0.4	
100.0	В	T520B107M006ASE070	63	8	70	1.1	1.0	0.4	
150.0 150.0	v v	T520V157M006ASE015 T520V157M006ASE025	95 95	10 10	15 25	2.9 2.2	2.6 2.0	1.2 0.9	
150.0 150.0	V V	T520V157M006ASE040 T520V157M006ASE045	95 95	10 10	40 45	1.8 1.7	1.6 1.5	0.7 0.7	
150.0	D	T520D157M006ASE015	95	10	15	3.2	2.8	1.3	
150.0 150.0	D D	T520D157M006ASE025 T520D157M006ASE055	95 95	10 10	25 55	2.4 1.7	2.2 1.5	1.0 0.7	
220.0 220.0	V V	T520V227M006ASE015 T520V227M006ASE025	139 139	10 10	15 25	2.9 2.2	2.6 2.0	1.2 0.9	
220.0	V	T520V227M006ASE040	139	10	40	1.8	1.6	0.7	
220.0 220.0	D D	T520D227M006ASE015 T520D227M006ASE040	139 139	10 10	15 40	3.2 1.9	2.8 1.7	1.3 0.8	
220.0	D	T520D227M006ASE050	139	10	50	1.7	1.6	0.7	
330.0 330.0	V V	T520V337M006ASE025 T520V337M006ASE040	208 208	10 10	25 40	2.2 1.8	2.0 1.6	0.9 0.7	
330.0 330.0	D D	T520D337M006ASE015 T520D337M006ASE025	208 208	10 10	15 25	3.2 2.4	2.8 2.2	1.3 1.0	
330.0	D	T520D337M006ASE040	208	10	40	1.9	1.7	0.8	
330.0 330.0	D Y	T520D337M006ASE045 T520Y337M006ATE025	208 208	10 10	45 25	1.8 2.5	1.6 2.3	0.7 1.0	
470.0	Y	T520Y477M006ATE025	296	10	25	2.5	2.3	1.0	
470.0 470.0	X X	T520X477M006ASE018 T520X477M006ASE035	296 296	10 10	18 35	3.0 2.2	2.7 2.0	1.2 0.9	
470.0	Х	T520X477M006ASE040	296	10	40	2.0	1.8	0.8	

### TE20 DATINGS & DADT NUMBED DECEDENCE

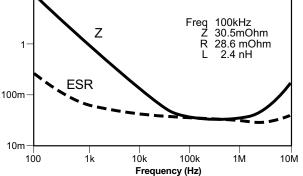
Capaci- tance µF	Case Size	KEMET Part Number	DC Leakage μA @ 25°C Max	DF% @ 25°C 120 Hz Max	ESR mΩ @ 25°C 100 kHz Max	Ripple Current A rms @ 25°C, 100 kHz Max		5°C,	
8 Volt Rating @ +85°C (6.4 Volt Rating at +105°C)									
33.0	В	T520B336M008ASE040	26	8	40	1.5	1.3	0.6	
33.0	В	T520B336M008ASE070	27	8	70	1.1	1.0	0.4	
150.0	D	T520D157M008ASE025	120	10	25	2.4	2.2	1.0	
150.0	D	T520D157M008ASE040	120	10	40	1.9	1.7	0.8	
150.0	D	T520D157M008ASE055	120	10	55	1.7	1.5	0.7	
		10 Volt Ratir	ng @ +85°C (8 Vol	t Rating at +10	)5°C)				
33.0	В	T520B336M010ASE040	33	8	40	1.5	1.3	0.6	
33.0	В	T520B336M010ASE070	33	8	70	1.1	1.0	0.4	
68.0	V	T520V686M010ASE045	68	10	45	1.7	1.5	0.7	
68.0	V	T520V686M010ASE060	68	10	60	1.4	1.3	0.6	
100.0	V	T520V107M010ASE018	100	10	18	2.6	2.4	1.1	
100.0	V	T520V107M010ASE025	100	10	25	2.2	2.0	0.9	
100.0	V	T520V107M010ASE045	100	10	45	1.7	1.5	0.7	
100.0	V	T520V107M010ASE050	100	10	50	1.6	1.4	0.6	
100.0	D	T520D107M010ASE018	100	10	18	3.2	2.8	1.3	
100.0	D	T520D107M010ASE055	100	10	55	1.7	1.5	0.7	
100.0	D	T520D107M010ASE080	100	10	80	1.4	1.2	0.5	
150.0	D	T520D157M010ASE025	150	10	25	2.4	2.2	1.0	
150.0	D	T520D157M010ASE040	150	10	40	1.9	1.7	0.8	
150.0	D	T520D157M010ASE055	150	10	55	1.7	1.5	0.7	
220.0	D	T520D227M010ASE018	220	10	18	2.9	2.6	1.2	
220.0	D	T520D227M010ASE025	220	10	25	2.4	2.2	1.0	
220.0	D	T520D227M010ASE040	220	10	40	1.9	1.7	0.8	
330.0	Х	T520X337M010ASE025	330	10	25	2.6	2.3	1.0	
330.0	Х	T520X337M010ASE040	330	10	40	2.0	1.8	0.8	
			@ +85°C (12.8 Vo	Ŭ	,				
33.0	V	T520V336M016ASE060	53	10	60	1.4	1.3	0.6	
47.0	V	T520V476M016ASE070	76	10	70	1.3	1.2	0.5	
47.0	D	T520D476M016ASE070	75	10	70	1.5	1.3	0.6	
		25 Volt Ratin	g @ +85°C (20 Vo	It Rating at +1	05°C)				
15.0	D	T520D156M025ASE080	38	10	80	1.4	1.2	0.5	

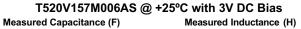
### **T520 RATINGS & PART NUMBER REFERENCE**

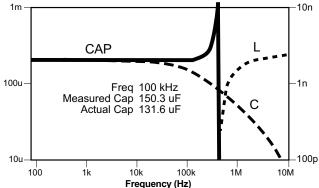
Newest values indicated in RED

### **TYPICAL FREQUENCY RESPONSE CURVES**

T520V157M006AS @ +25°C with 3VDC Bias Impedance and ESR (Ohms)







T520D337M006AS@ +25°C with3VDC Bias Impedance and ESR (Ohms)

